

Features

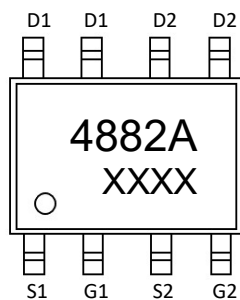
- Trench Power LV MOSFET technology
- High Density Cell Design for Low $R_{DS(ON)}$
- High Speed switching

Application

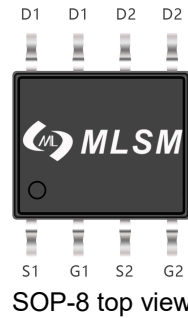
- Battery protection
- Load switch
- Power management

Product Summary

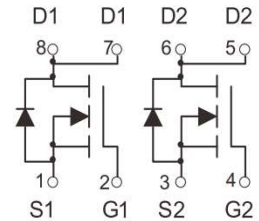
V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
40V	20mΩ@10V	8A
	35mΩ@4.5V	



4882A: Device code
 XXXX: Code



SOP-8 top view



Schematic diagram



Halogen-Free

Marking and pin assignment

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V _{DS}	Drain-Source Breakdown Voltage		40	V
V _{GS}	Gate-Source Voltage		±20	V
T _J	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-55 to 150	°C
I _S	Diode Continuous Forward Current	Tc=25°C	8	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	38	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	8	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	2	W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		60	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLSQ4882A	SOP-8	4882A	3,000	6,000	42,000	13"reel

Electrical Characteristics (T _J =25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T _J = 25°C (unless otherwise stated)						
B _{V(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	40	–	–	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V	–	–	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	–	–	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =8A	–	15	20	mΩ
		V _{GS} =4.5V, I _D =4A	–	24	35	mΩ
Dynamic Electrical Characteristics @ T _J = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =20V, V _{GS} =0V, f=1MHz	–	421	–	pF
C _{OSS}	Output Capacitance		–	115	–	pF
C _{RSS}	Reverse Transfer Capacitance		–	13	–	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =20V, I _D =8A, V _{GS} =10V	–	6.8	–	nC
Q _{gs}	Gate Source Charge		–	1.1	–	nC
Q _{gd}	Gate Drain Charge		–	1.3	–	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =20V, R _L =2.5Ω, V _{GS} =10V, R _G =3Ω	–	3.8	–	nS
t _r	Turn-on Rise Time		–	2.5	–	nS
t _{d(off)}	Turn-Off Delay Time		–	14.4	–	nS
t _f	Turn-Off Fall Time		–	2	–	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =8A	–	–	1.2	V

Typical Operating Characteristics

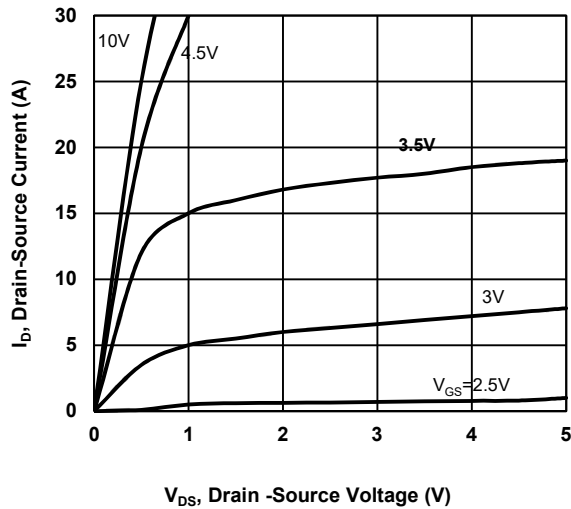


Fig1. Typical Output Characteristics

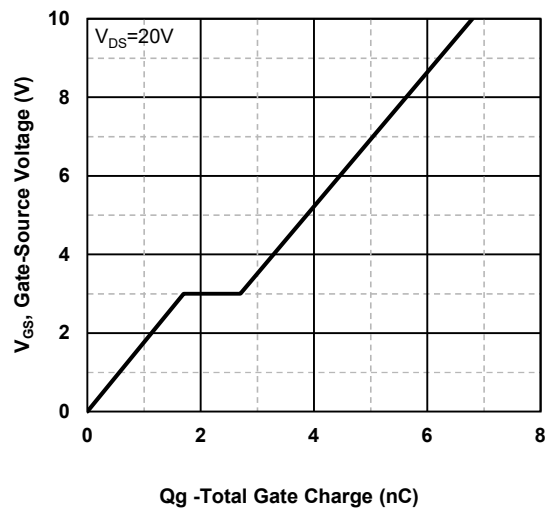


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

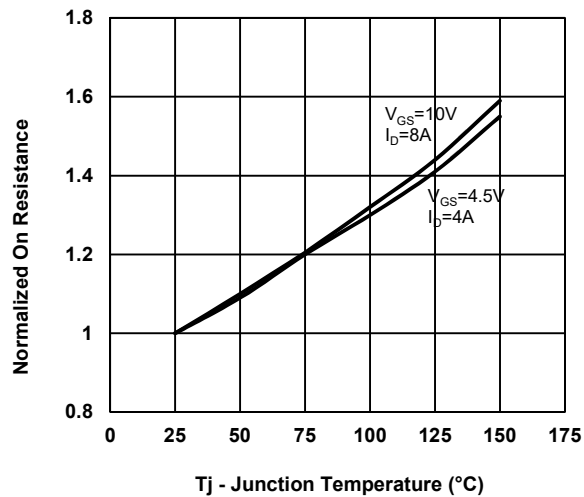


Fig3. Normalized On-Resistance Vs. Temperature

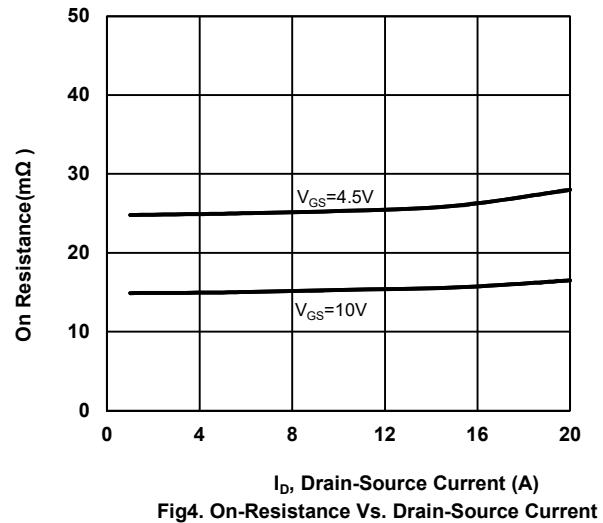


Fig4. On-Resistance Vs. Drain-Source Current

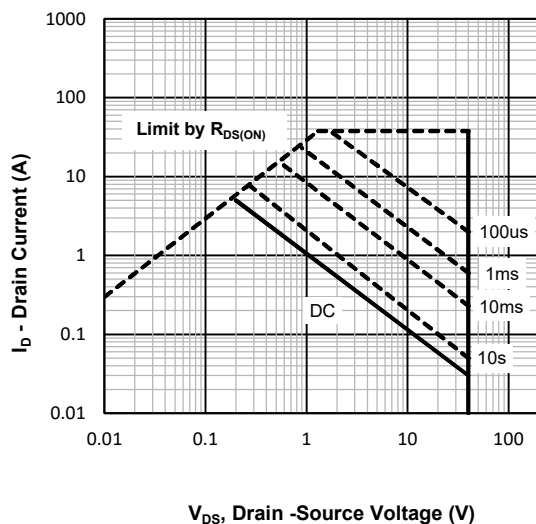


Fig5. Maximum Safe Operating Area

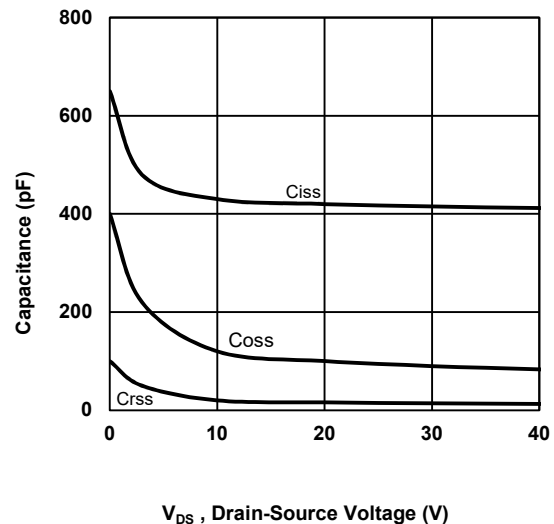
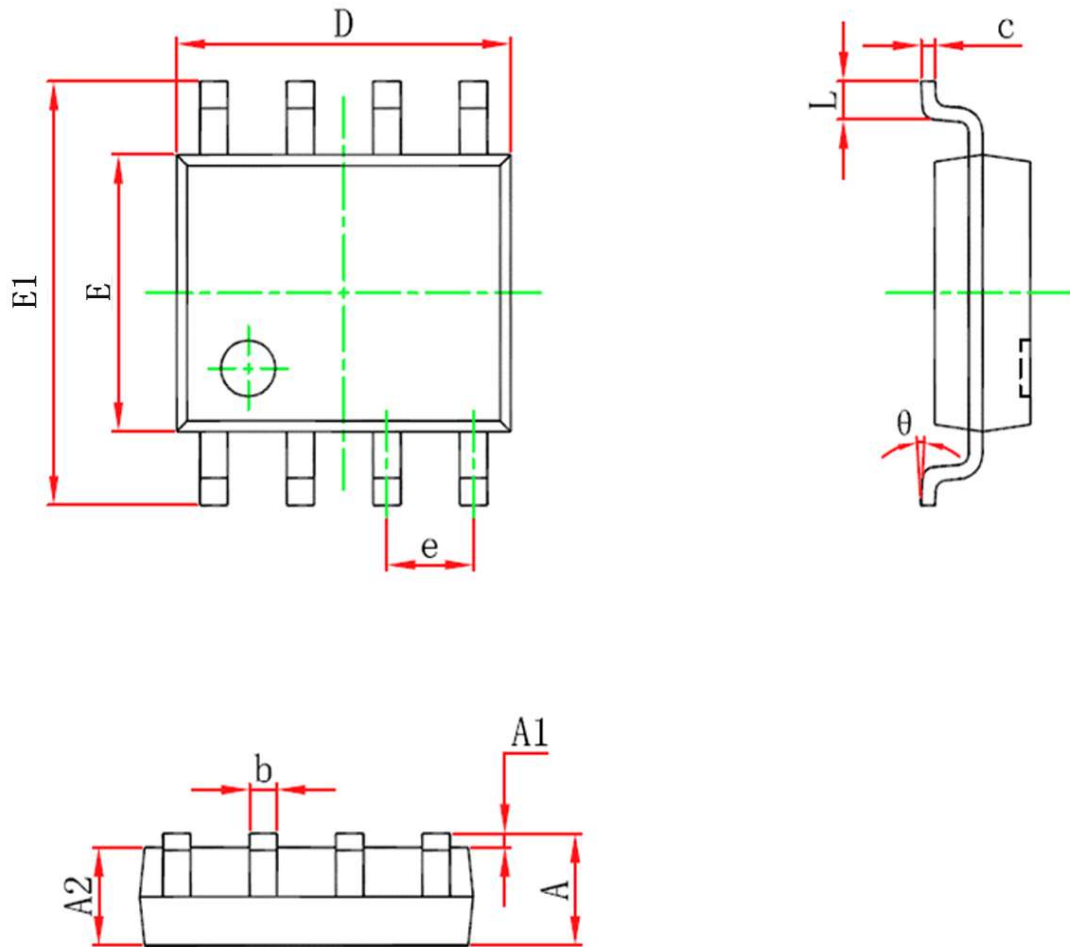


Fig6 Typical Capacitance Vs. Drain-Source Voltage

SOP-8 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	1.450	1.750	0.057	0.068
A1	0.100	0.250	0.003	0.009
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.012	0.020
c	0.170	0.250	0.006	0.009
D	4.700	5.100	0.185	0.200
e	1.270(BSC)		0.050(BSC)	
E	3.800	4.000	0.149	0.157
E1	5.800	6.200	0.228	0.244
L	0.400	1.270	0.015	0.050
θ	0°	8°	0°	8°